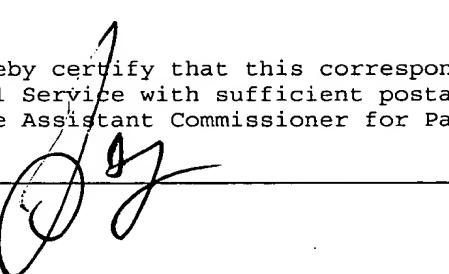




GR 97 P 1049 D

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By: 

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U.S. PATENT AND TRADEMARK OFFICE  
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2811

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Bernhard Schaetzler et al.

Applic. No. : 09/688,465

Filed : October 16, 2000

Title : Electronic Component With An Integrated Circuit Mounted On An Island Of A Lead Frame

Examiner : Nitin Parekh

Group Art Unit : 2811

A M E N D M E N T

Hon. Commissioner of Patents and Trademarks,  
Washington, D. C. 20231

Sir :

Responsive to the Office action dated November 18, 2002 kindly amend the above-identified application as follows:

In the Claims:

Claim 1(amended). An electronic component, comprising:

*B1*  
a thin quad flat package including: